Intel Product Change Notification

Change Notification #:	116773 - 00
Change Title:	For Select Intel® SSD D3-S4510 Series and
	Intel® SSD D3-S4610 Series SKUs,
	PCN 116773-00, Product Design,
	Firmware Update
Date of Publication:	February 20, 2019

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	April 21, 2019

Description of Change to the Customer:

The Intel® SSD D3-S4510 Series and Intel® SSD D3-S4610 Series SKUs listed in the Products Affected table below will have the firmware version updated from XCV10100 to XCV10110. The changes in the new firmware version are incremental improvements from previous version. Inventory will transition in the Intel factory on or beyond the above date to replace older firmware version with the latest version.

Customer Impact of Change and Recommended Action:

Since the firmware update has incremental improvement over the previous version, Intel anticipates no product impact with this firmware, and re-qualification is not recommended.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Name	Product Code	MM#	Pre Change TA	Pre Change SA	Post Change TA	Post Change SA
Intel® SSD D3-S4510 Series (240GB, 2.5in SATA 6Gb/s, 3D2, TLC) Generic Single Pack	SSDSC2KB240G801	963339	J80281-000	J80322-000	J80281-001	J80322-001
Intel® SSD D3-S4510 Series (480GB, 2.5in SATA 6Gb/s, 3D2, TLC) Generic Single Pack	SSDSC2KB480G801	963340	J80282-000	J80324-000	J80282-001	J80324-001
Intel® SSD D3-S4510 Series (960GB, 2.5in SATA 6Gb/s, 3D2, TLC) Generic Single Pack	SSDSC2KB960G801	963341	J80283-000	J80327-000	J80283-001	J80327-001
Intel® SSD D3-S4610 Series (240GB, 2.5in SATA 6Gb/s, 3D2, TLC) Generic Single Pack	SSDSC2KG240G801	963345	J80299-000	J80311-000	J80299-001	J80311-001
Intel® SSD D3-S4610 Series (480GB, 2.5in SATA 6Gb/s, 3D2, TLC) Generic Single Pack	SSDSC2KG480G801	963346	J80300-000	J80313-000	J80300-001	J80313-001
Intel® SSD D3-S4610 Series (960GB, 2.5in SATA 6Gb/s, 3D2, TLC) Generic Single Pack	SSDSC2KG960G801	963347	J80301-000	J80315-000	J80301-001	J80315-001
Intel® SSD D3-S4510 Series (240GB, 2.5in SATA 6Gb/s, 3D2, TLC) Generic 50 Pack	SSDSC2KB240G8	963349	J80286-000	J80322-000	J80286-001	J80322-001
Intel® SSD D3-S4510 Series (480GB, 2.5in SATA 6Gb/s, 3D2, TLC) Generic 50 Pack	SSDSC2KB480G8	963350		J80324-000	J80287-001	J80324-001
Intel® SSD D3-S4510 Series (960GB, 2.5in SATA 6Gb/s, 3D2, TLC) Generic 50 Pack	SSDSC2KB960G8	963351	J80288-000	J80327-000	J80288-001	J80327-001
Intel® SSD D3-S4610 Series (240GB, 2.5in SATA 6Gb/s, 3D2, TLC) Generic 50 Pack	SSDSC2KG240G8	963355	J80303-000	J80311-000	J80303-001	J80311-001
Intel® SSD D3-S4610 Series (480GB, 2.5in SATA 6Gb/s, 3D2, TLC) Generic 50 Pack	SSDSC2KG480G8	963356	J80304-000	J80313-000	J80304-001	J80313-001
Intel® SSD D3-S4610 Series (960GB, 2.5in SATA 6Gb/s, 3D2, TLC) Generic 50 Pack	SSDSC2KG960G8	963357	J80305-000	J80315-000	J80305-001	J80315-001

PCN Revision History:

Date of Revision:					
February 20, 2019					

Revision Number: 00

Reason: Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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